

LOCTITE ABLESTIK ATB 110A

May 2014

PRODUCT DESCRIPTION

LOCTITE ABLESTIK ATB 110A provides the following product characteristics:

Technology	Rubberized Epoxy
Appearance	Transparent
Cure	Heat cure
Product Benefits	<ul style="list-style-type: none"> • Excellent wettability • Easy die pick up • Excellent package reliability • One step lamination
Application	Die attach
Filler Type	Silica
Typical Package Application	Die to die stack
Carrier Type	Polyolefin
Adhesive Thickness	10µm
Carrier Film Thickness	85µm
Wafer Size	8 and 12 in

LOCTITE ABLESTIK ATB 110A adhesive film is formulated for use in wafer lamination processes. It combines process ease with the proven reliability of a hybrid chemistry-based die attach material.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Work Life @ 25°C, days	30
Shelf Life @ 5°C (from date of manufacture), days	365

TYPICAL PROCESS DATA

Wafer Backside Lamination

Temperature, °C	65
Pressure, psi	30
Taping Duration, ft/ minute	1

Chip Attach

Temperature, °C	100 to 130
Pressure, kg-f	1 to 2
Attach Duration, second	1

TYPICAL CURING PERFORMANCE

Cure Schedule

30 minute ramp to 130°C + 1 hour @ 130°C

Alternate Cure Schedule

30 minute ramp to 120°C + 1 hour @ 120°C

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

Physical Properties

Coefficient of Thermal Expansion :	
Below Tg, ppm/°C	62
Above Tg, ppm/°C	224
Glass Transition Temperature (Tg) by TMA, °C	57
Tensile Modulus, DMTA :	
@ -65 °C	N/mm ² 3,740 (psi) (543,000)
@ 25 °C	N/mm ² 1,860 (psi) (270,000)
@ 150 °C	N/mm ² 5.0 (psi) (670)
@ 200 °C	N/mm ² 4.9 (psi) (710)
@ 250 °C	N/mm ² 4.69 (psi) (680)
Weight Loss @ 250°C, %	1
Moisture Absorption @ Saturation, wt.% @ 85°C/85%RH	1.5

TYPICAL PERFORMANCE OF CURED MATERIAL

Miscellaneous

Die Shear Strength :

2.5 x 2.5 mm Si die frontside, kg-f:	
@ 25°C	15
@ 260°C	1

GENERAL INFORMATION

For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

DIRECTIONS FOR USE

1. Ensure all surfaces to be bonded are free from surface contamination.
2. Adhesive must be completely used within the product's recommended work life.
3. Remove the tape reel from the moisture-resistant package and load into the tape application machine.
4. Store unused adhesive film in the original sealed moisture-resistant package until needed.

Storage

These adhesive film should be stored at -15 to 5°C, in its original moisture resistant packaging. Partially used reels should be stored under dry conditions at -15 to 5°C.

To minimize moisture absorption, we recommend storing the adhesive film in the sealed moisture-resistant package until needed.

Optimal Storage: 5 °C to -15°C. Storage below -15 °C or greater than 5 °C can adversely affect product properties.

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

$(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$

$\text{kV/mm} \times 25.4 = \text{V/mil}$

$\text{mm} / 25.4 = \text{inches}$

$\text{N} \times 0.225 = \text{lb}$

$\text{N/mm} \times 5.71 = \text{lb/in}$

$\text{N/mm}^2 \times 145 = \text{psi}$

$\text{MPa} = \text{N/mm}^2$

$\text{MPa} \times 145 = \text{psi}$

$\text{N}\cdot\text{m} \times 8.851 = \text{lb}\cdot\text{in}$

$\text{N}\cdot\text{m} \times 0.738 = \text{lb}\cdot\text{ft}$

$\text{N}\cdot\text{mm} \times 0.142 = \text{oz}\cdot\text{in}$

$\text{mPa}\cdot\text{s} = \text{cP}$

Disclaimer

Note:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

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Reference 0.2